Single 2-input multiplexer Rev. 6 — 31 December 2012

Product data sheet

1. **General description**

The 74LVC1G157 is a single 2-input multiplexer which select data from two data inputs (I0 and I1) under control of a common data select input (S). The state of the common data select input determines the particular register from which the data comes. The output (Y) presents the selected data in the true (non-inverted) form.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V applications.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Schmitt-trigger action at all inputs makes the circuit highly tolerant to slower input rise and fall times.

Features and benefits 2.

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard:
 - ◆ JESD8-7 (1.65 V to 1.95 V)
 - ◆ JESD8-5 (2.3 V to 2.7 V)
 - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- \pm 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | | | |
|--------------|-------------------|-------|---|---------|--|--|--|
| | Temperature range | Name | Description | Version | | | |
| 74LVC1G157GW | –40 °C to +125 °C | SC-88 | plastic surface-mounted package; 6 leads | SOT363 | | | |
| 74LVC1G157GV | –40 °C to +125 °C | SC-74 | plastic surface-mounted package (TSOP6); 6 leads | SOT457 | | | |
| 74LVC1G157GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm | SOT886 | | | |
| 74LVC1G157GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm | SOT891 | | | |
| 74LVC1G157GN | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm | SOT1115 | | | |
| 74LVC1G157GS | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body 1.0 \times 1.0 \times 0.35 mm | SOT1202 | | | |

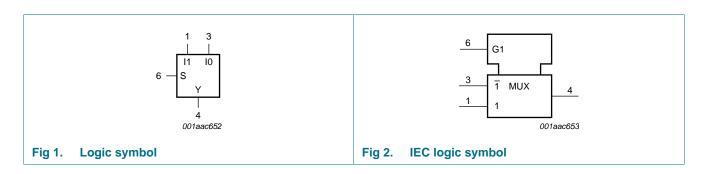
4. Marking

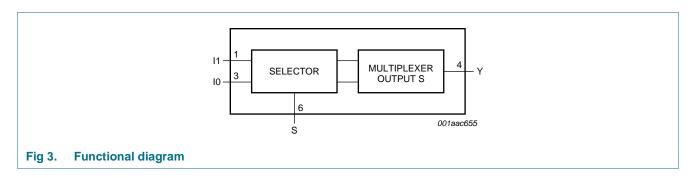
Table 2. Marking

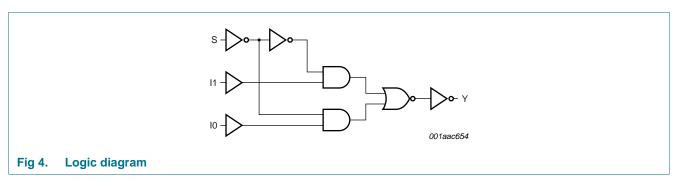
| Type number | Marking code ^[1] |
|--------------|-----------------------------|
| 74LVC1G157GW | YP |
| 74LVC1G157GV | YP |
| 74LVC1G157GM | YP |
| 74LVC1G157GF | YP |
| 74LVC1G157GN | YP |
| 74LVC1G157GS | YP |

^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

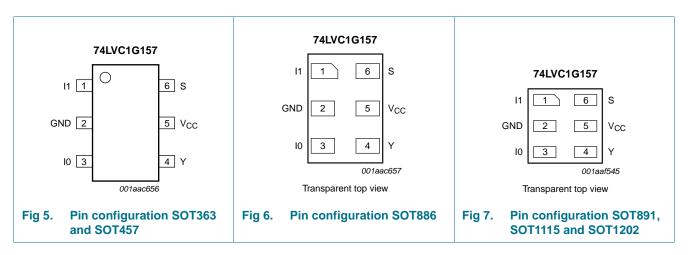






6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

| Symbol | Pin | Description |
|-----------------|-----|--------------------------|
| I 1 | 1 | data input from source 1 |
| GND | 2 | ground (0 V) |
| 10 | 3 | data input from source 0 |
| Υ | 4 | multiplexer output |
| V _{CC} | 5 | supply voltage |
| S | 6 | common data select input |

7. Functional description

Table 4. Function table[1]

| Inputs | | | Output |
|--------|----|----|--------|
| S | l1 | 10 | Υ |
| L | X | L | L |
| L | X | Н | Н |
| Н | L | X | L |
| Н | Н | X | Н |

^[1] H = HIGH voltage level;

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|--------------------------------|-----------------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +6.5 | V |
| I_{IK} | input clamping current | $V_I < 0 V$ | -50 | - | mA |
| V_{I} | input voltage | | <u>[1]</u> –0.5 | +6.5 | V |
| I_{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0 V$ | - | ±50 | mA |
| V_{O} | output voltage | Active mode | [1][2] -0.5 | $V_{CC} + 0.5$ | V |
| | | Power-down mode | [1][2] -0.5 | +6.5 | V |
| Io | output current | $V_O = 0 V \text{ to } V_{CC}$ | - | ±50 | mA |
| I_{CC} | supply current | | - | 100 | mA |
| I_{GND} | ground current | | -100 | - | mA |
| P_{tot} | total power dissipation | T_{amb} = -40 °C to +125 °C | [3] _ | 250 | mW |
| T_{stg} | storage temperature | | -65 | +150 | °C |

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

74LVC1G157

L = LOW voltage level;

X = don't care.

^[2] When $V_{CC} = 0 \text{ V}$ (Power-down mode), the output voltage can be 5.5 V in normal operation.

^[3] For SC-88 and SC-74 packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 package: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|-------------------------------------|--|------|-----|----------|------|
| V_{CC} | supply voltage | | 1.65 | - | 5.5 | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | Active mode | - | - | V_{CC} | V |
| | | V _{CC} = 0 V; Power-down mode | - | - | 5.5 | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | V_{CC} = 1.65 V to 2.7 V | - | - | 20 | ns/V |
| | | V _{CC} = 2.7 V to 5.5 V | - | - | 10 | ns/V |

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 ° | °C to +85 | 5 °C | -40 °C to | Unit | |
|-----------------|--------------------------|---|-----------------------|-----------|---------------------|-----------------------|---------------------|----|
| | | Min | Typ[1] | Max | Min | Max | | |
| V_{IH} | HIGH-level | V _{CC} = 1.65 V to 1.95 V | 0.65V _{CC} | - | - | 0.65V _{CC} | - | V |
| | input voltage | V _{CC} = 2.3 V to 2.7 V | 1.7 | - | - | 1.7 | - | V |
| | | V _{CC} = 2.7 V to 3.6 V | 2.0 | - | - | 2.0 | - | V |
| | | V _{CC} = 4.5 V to 5.5 V | 0.7V _{CC} | - | - | $0.7V_{CC}$ | - | V |
| V _{IL} | LOW-level | V _{CC} = 1.65 V to 1.95 V | - | - | 0.35V _{CC} | - | 0.35V _{CC} | V |
| | input voltage | V _{CC} = 2.3 V to 2.7 V | - | - | 0.7 | - | 0.7 | V |
| | | V _{CC} = 2.7 V to 3.6 V | - | - | 0.8 | - | 0.8 | V |
| | | V _{CC} = 4.5 V to 5.5 V | - | - | $0.3V_{CC}$ | - | $0.3V_{CC}$ | V |
| V _{OH} | HIGH-level | $V_I = V_{IH}$ or V_{IL} | | | | | | |
| | output voltage | $I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ | V _{CC} – 0.1 | - | - | V _{CC} – 0.1 | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | 1.54 | - | 0.95 | - | V |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | 2.15 | - | 1.7 | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | 2.50 | - | 1.9 | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.3 | 2.62 | - | 2.0 | - | V |
| | | $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.8 | 4.11 | - | 3.4 | - | V |
| V _{OL} | LOW-level | $V_I = V_{IH}$ or V_{IL} | | | | | | |
| | output voltage | $I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ | - | - | 0.10 | - | 0.10 | V |
| | | $I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | 0.07 | 0.45 | - | 0.70 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | 0.12 | 0.30 | - | 0.45 | V |
| | | I_{O} = 12 mA; V_{CC} = 2.7 V | - | 0.17 | 0.40 | - | 0.60 | V |
| | | $I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | 0.33 | 0.55 | - | 0.80 | ٧ |
| | | $I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | 0.39 | 0.55 | - | 0.80 | V |
| I _I | input leakage current | $V_I = 5.5 \text{ V or GND};$ $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$ | - | ±0.1 | ±5 | - | ±20 | μΑ |

 Table 7.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol Parameter | | Conditions | -40 °C to +85 °C | | | -40 °C to +125 °C | | Unit |
|------------------|---------------------------------|---|------------------|--------|-----|-------------------|------|------|
| | | | Min | Typ[1] | Max | Min | Max | |
| I _{OFF} | power-off leakage current | $V_{CC} = 0 \text{ V}$; $V_I \text{ or } V_O = 5.5 \text{ V}$ | - | ±0.1 | ±10 | - | ±20 | μΑ |
| I _{CC} | supply current | $V_I = 5.5 \text{ V or GND}; I_O = 0 \text{ A};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ | - | 0.1 | 10 | - | 40 | μΑ |
| ΔI_{CC} | additional supply current | per pin; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}$ | - | 5 | 500 | - | 5000 | μΑ |
| Cı | input capacitance | V_{CC} = 3.3 V; V_I = GND to V_{CC} | - | 2.5 | - | - | - | pF |

^[1] All typical values are measured at T_{amb} = 25 °C.

11. Dynamic characteristics

 Table 8.
 Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for load circuit see Figure 9.

| Symbol | Parameter | Conditions | | -40 °C to +85 °C | | | -40 °C to | +125 °C | Unit |
|-----------------|-------------------------------|--|-----|------------------|--------|------|-----------|---------|------|
| | | | Ī | Min | Typ[1] | Max | Min | Max | |
| t _{pd} | propagation delay | I0, I1 to Y; see Figure 8 | [2] | | ' | | | | ' |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 1.5 | 4.3 | 11.0 | 1.5 | 13.0 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.0 | 2.9 | 6.1 | 1.0 | 7.6 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | | 1.0 | 3.1 | 5.6 | 1.0 | 7.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.0 | 2.7 | 5.0 | 1.0 | 6.3 | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | 0.5 | 2.2 | 4.0 | 0.5 | 5.0 | ns |
| | | S to Y; see Figure 8 | [2] | | | | | | |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 1.5 | 4.3 | 11.0 | 1.5 | 13.0 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.0 | 2.9 | 6.9 | 1.0 | 8.6 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | | 1.0 | 3.3 | 5.9 | 1.0 | 7.4 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.0 | 2.9 | 5.0 | 1.0 | 6.3 | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | 0.5 | 2.3 | 4.0 | 0.5 | 5.0 | ns |
| C_{PD} | power dissipation capacitance | $V_I = GND \text{ to } V_{CC}; V_{CC} = 3.3 \text{ V}$ | [3] | - | 18 | - | - | - | pF |

^[1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.8$ V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

 $P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}{}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in Volts;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

^[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

12. Waveforms

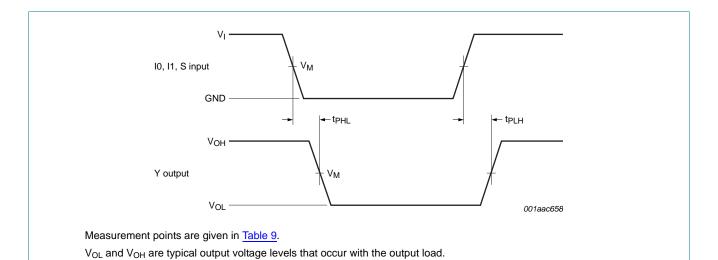


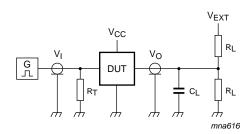
Table 9. Measurement points

Fig 8.

| Table of Modern Street | | | |
|------------------------|--------------------|--------------------|--|
| Supply voltage | Input | Output | |
| V _{CC} | V _M | V _M | |
| 1.65 V to 1.95 V | 0.5V _{CC} | 0.5V _{CC} | |
| 2.3 V to 2.7 V | 0.5V _{CC} | 0.5V _{CC} | |
| 2.7 V | 1.5 V | 1.5 V | |
| 3.0 V to 3.6 V | 1.5 V | 1.5 V | |
| 4.5 V to 5.5 V | 0.5V _{CC} | 0.5V _{CC} | |

Data inputs (I0, I1) and common data select input (S) to output (Y) propagation delays

Single 2-input multiplexer



Test data is given in Table 10.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance; should be equal to the output impedance Z_o of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

Table 10. Test data

| Supply voltage | Input | | Load | | V _{EXT} |
|------------------|-----------------|---------------|-------|--------------|-------------------------------------|
| V _{CC} | Vı | $t_r = t_f$ | CL | R_L | t _{PLH} , t _{PHL} |
| 1.65 V to 1.95 V | V _{CC} | \leq 2.0 ns | 30 pF | 1 kΩ | open |
| 2.3 V to 2.7 V | V_{CC} | ≤ 2.0 ns | 30 pF | 500 Ω | open |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open |
| 4.5 V to 5.5 V | V _{CC} | ≤ 2.5 ns | 50 pF | 500 Ω | open |

13. Package outline

Plastic surface-mounted package; 6 leads

SOT363

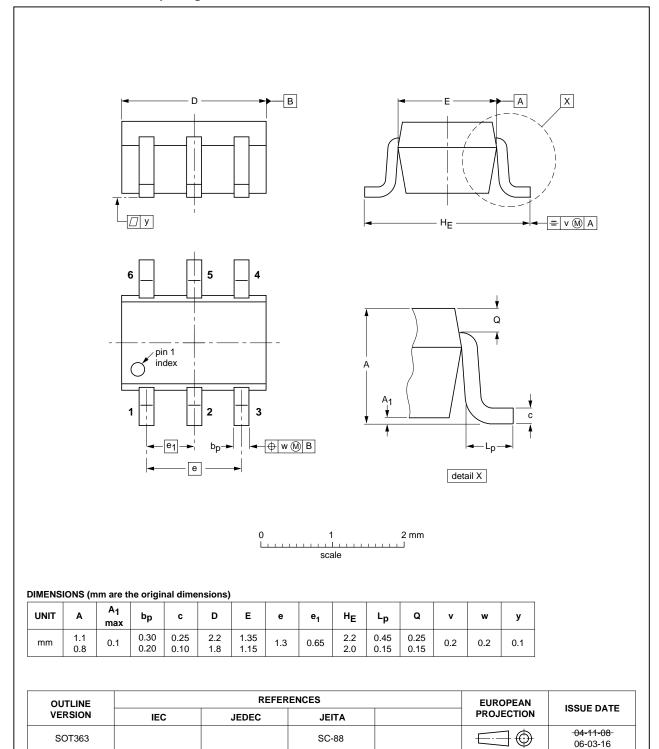


Fig 10. Package outline SOT363 (SC-88)

Plastic surface-mounted package (TSOP6); 6 leads

SOT457

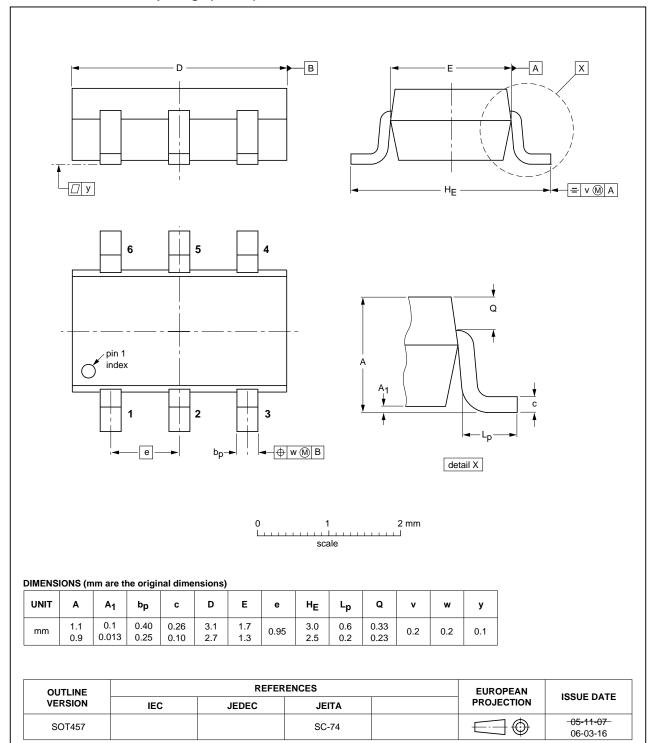


Fig 11. Package outline SOT457 (SC-74)

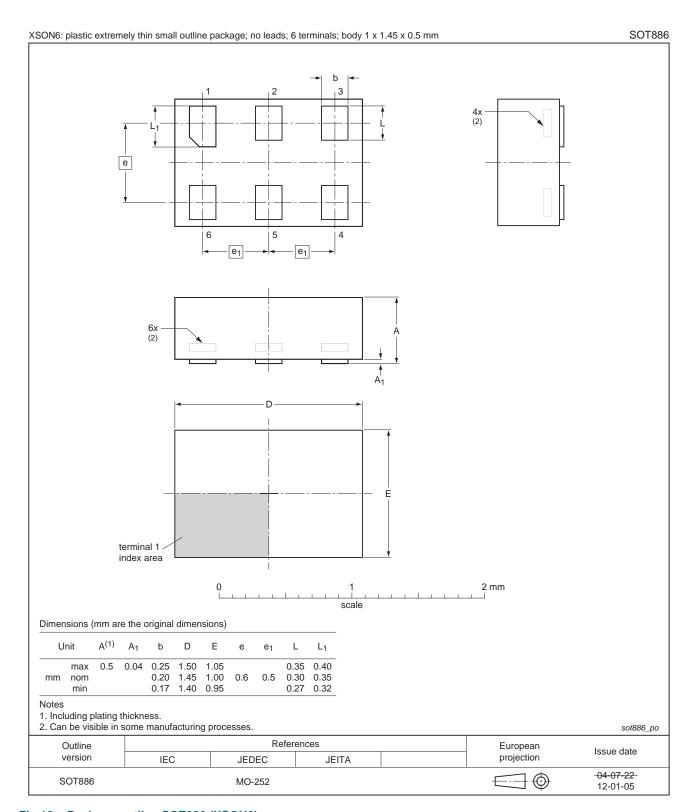


Fig 12. Package outline SOT886 (XSON6)

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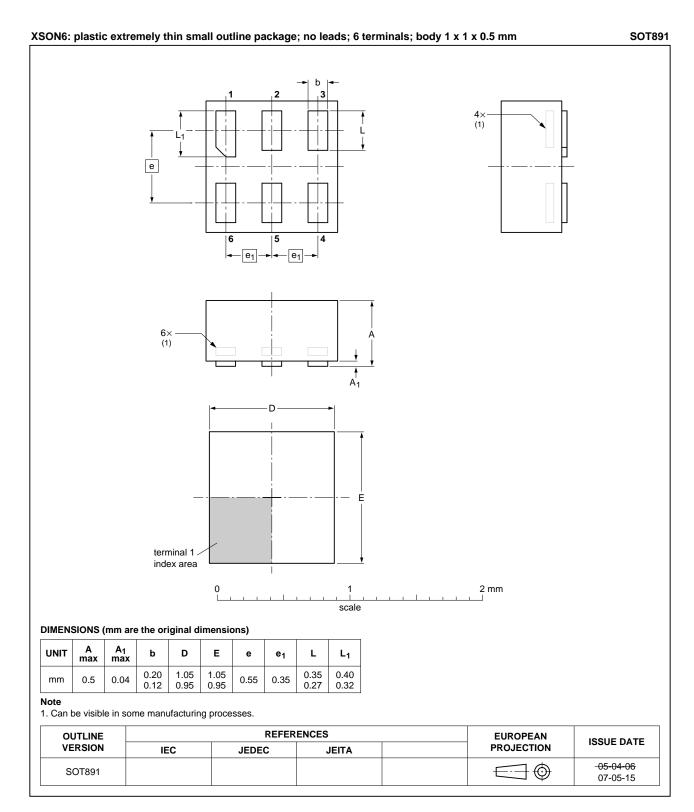


Fig 13. Package outline SOT891 (XSON6)

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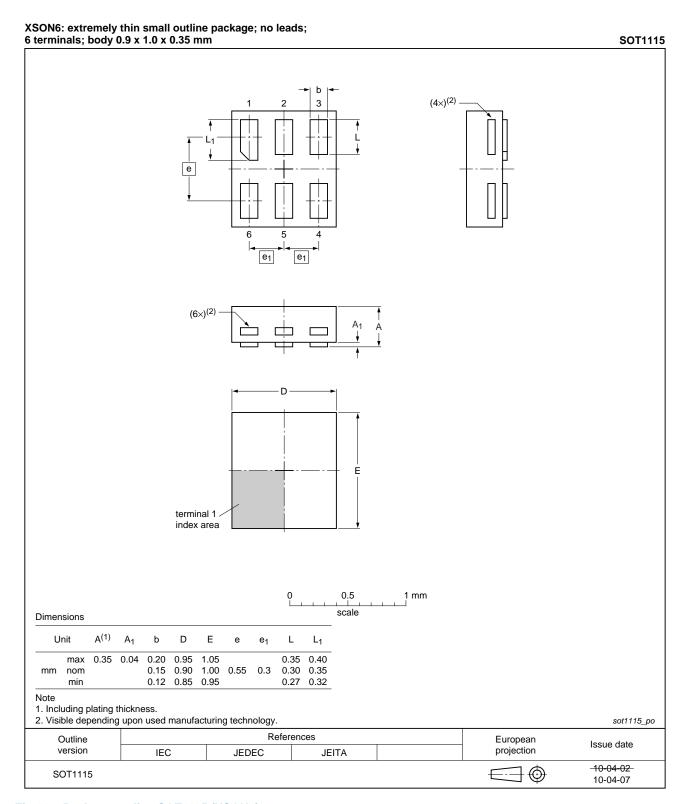


Fig 14. Package outline SOT1115 (XSON6)

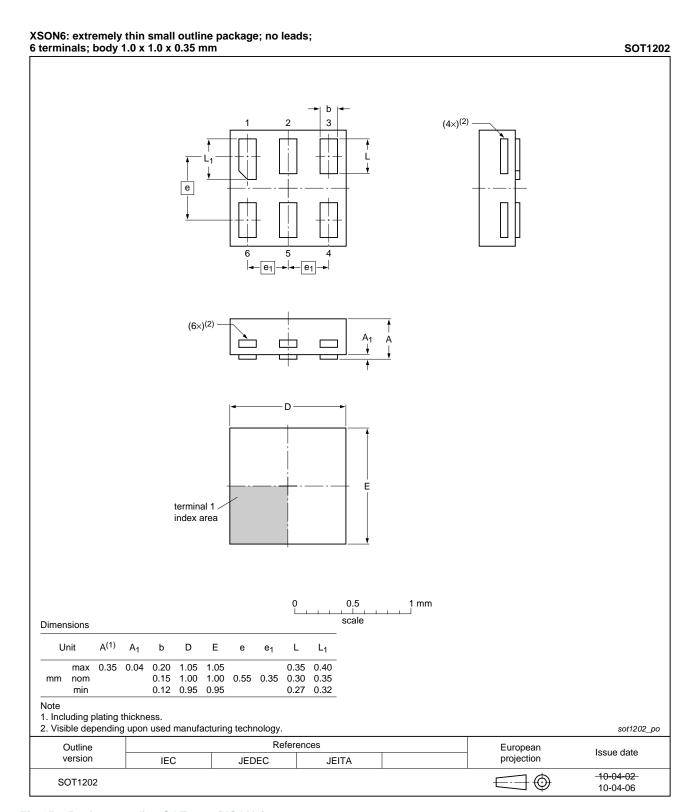


Fig 15. Package outline SOT1202 (XSON6)

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14. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

15. Revision history

Table 12. Revision history

| | • | | | |
|----------------|---------------------------------|---------------------------|----------------------|----------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| 74LVC1G157 v.6 | 20121231 | Product data sheet | - | 74LVC1G157 v.5 |
| Modifications: | Package ou | tline drawing of SOT886 (| Figure 12) modified. | |
| 74LVC1G157 v.5 | 20111206 | Product data sheet | - | 74LVC1G157 v.4 |
| Modifications: | Legal pages | s updated. | | |
| 74LVC1G157 v.4 | 20101028 | Product data sheet | - | 74LVC1G157 v.3 |
| 74LVC1G157 v.3 | 20070712 | Product data sheet | - | 74LVC1G157 v.2 |
| 74LVC1G157 v.2 | 20061011 | Product data sheet | - | 74LVC1G157 v.1 |
| 74LVC1G157 v.1 | 20050425 | Product data sheet | - | - |
| | | | | |

16. Legal information

16.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Single 2-input multiplexer

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